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XMC1300

Microcontroller Series
for Industrial Applications

XMC1000 Family

ARM® Cortex™-M0
32-bit processor core

Data Sheet

V1.4 2014-05

Microcontrollers

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Revision History: V1.4 2014-05

Previous Version: V1.3	
Page	Subjects
Page 12	ADC channels of Table 2 is updated. Table 3 is added.
Page 12	Description for Chip Identification Number of Section 1.4 is updated.
Page 20	The pad type is corrected for P1.6 in Table 6.
Page 32	The t_{C12} , f_{C12}, t_{C10}, f_{C10}, t_{C8} and f_{C8} parameters are updated in Table 12.
Page 35	Figure 8 is added.
Page 38	The t_{SR} and t_{TSAL} parameters are updated in Table 15.
Page 41	Parameter name for t_{PSER} is updated. The $N_{WSFLASH}$ parameter and test condition for t_{RET} are added to Table 18.
Page 44	The min value for V_{DDPBO} parameter is added to Table 20. Footnote 1 is updated.
Page 46	The Δf_{LTT} parameter is added to Table 21.
Page 47	Figure 14 is added.

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About this Document

This Data Sheet is addressed to embedded hardware and software developers. It provides the reader with detailed descriptions about the ordering designations, available features, electrical and physical characteristics of the XMC1300 series devices.

The document describes the characteristics of a superset of the XMC1300 series devices. For simplicity, the various device types are referred to by the collective term XMC1300 throughout this document.

XMC1000 Family User Documentation

The set of user documentation includes:

- **Reference Manual**
  - decribes the functionality of the superset of devices.
- **Data Sheets**
  - list the complete ordering designations, available features and electrical characteristics of derivative devices.
- **Errata Sheets**
  - list deviations from the specifications given in the related Reference Manual or Data Sheets. Errata Sheets are provided for the superset of devices.

Attention: Please consult all parts of the documentation set to attain consolidated knowledge about your device.

Application related guidance is provided by **Users Guides** and **Application Notes**.

Please refer to **http://www.infineon.com/xmc1000** to get access to the latest versions of those documents.

1 Summary of Features

The XMC1300 devices are members of the XMC1000 family of microcontrollers based on the ARM Cortex-M0 processor core. The XMC1300 series addresses the real-time control needs of motor control, digital power conversion. It also features peripherals for LED Lighting applications.

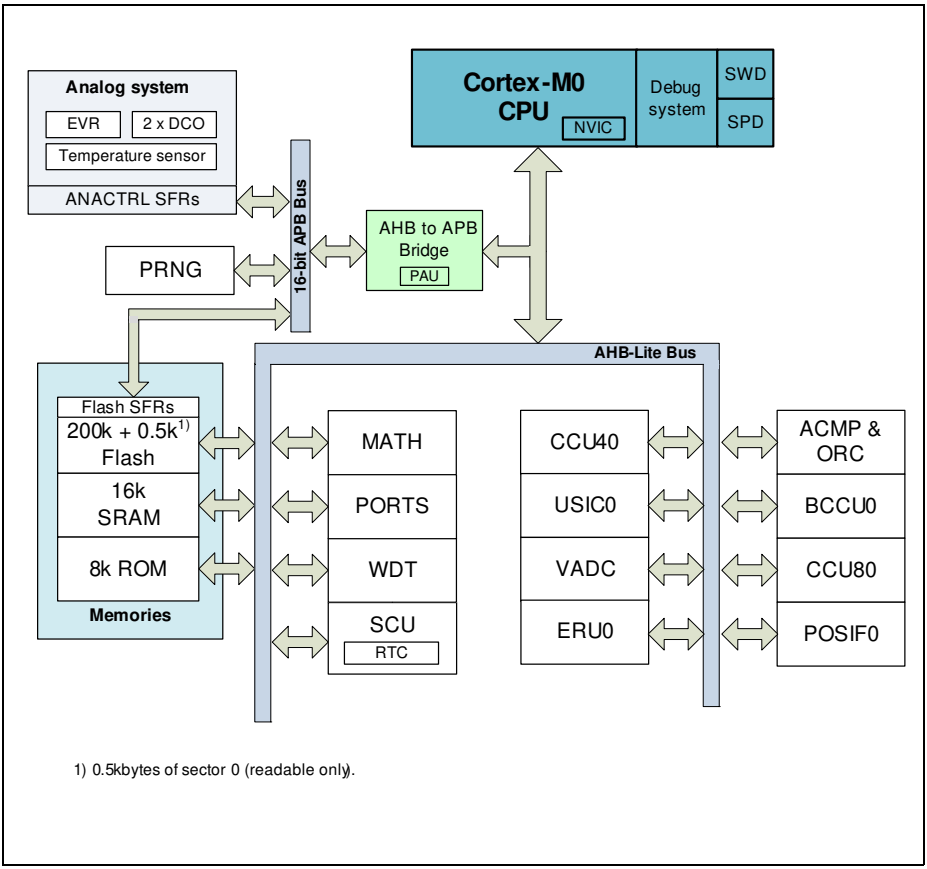

Figure 1 System Block Diagram

CPU Subsystem

- CPU Core
  - High Performance 32-bit ARM Cortex-M0 CPU
  - Most of 16-bit Thumb instruction set

  - Subset of 32-bit Thumb2 instruction set
  - High code density with 32-bit performance
  - Single cycle 32-bit hardware multiplier
  - System timer (SysTick) for Operating System support
  - Ultra low power consumption
- Nested Vectored Interrupt Controller (NVIC)
- Event Request Unit (ERU) for programmable processing of external and internal service requests
- MATH Co-processor (MATH), consists of a CORDIC unit for trigonometric calculation and a division unit

On-Chip Memories

- 8 kbytes on-chip ROM
- 16 kbytes on-chip high-speed SRAM
- up to 200 kbytes on-chip Flash program and data memory

Communication Peripherals

- Two Universal Serial Interface Channels (USIC), usable as UART, double-SPI, quad-SPI, IIC, IIS and LIN interfaces

Analog Frontend Peripherals

- A/D Converters, up to 12 channels, includes 2 sample and hold stages and a fast 12-bit analog to digital converter with adjustable gain
- Up to 8 channels of out of range comparators (ORC)
- Up to 3 fast analog comparators (ACMP)
- Temperature Sensor (TSE)

Industrial Control Peripherals

- Capture/Compare Units 4 (CCU4) for use as general purpose timers
- Capture/Compare Units 8 (CCU8) for motor control and power conversion
- Position Interfaces (POSIF) for hall and quadrature encoders and motor positioning
- Brightness and Colour Control Unit (BCCU), for LED color and dimming application

System Control

- Window Watchdog Timer (WDT) for safety sensitive applications
- Real Time Clock module with alarm support (RTC)
- System Control Unit (SCU) for system configuration and control
- Pseudo random number generator (PRNG), provides random data with fast generation times

Input/Output Lines

- Tri-stated in input mode
- Push/pull or open drain output mode
- Configurable pad hysteresis

On-Chip Debug Support

- Support for debug features: 4 breakpoints, 2 watchpoints
- Various interfaces: ARM serial wire debug (SWD), single pin debug (SPD)

1.1 Ordering Information

The ordering code for an Infineon microcontroller provides an exact reference to a specific product. The code “XMC1<DDD>-<Z><PPP><T><FFFF>” identifies:

- <DDD> the derivatives function set
- <Z> the package variant
  - T: TSSOP
  - Q: VQFN
- <PPP> package pin count
- <T> the temperature range:
  - F: -40°C to 85°C
  - X: -40°C to 105°C
- <FFFF> the Flash memory size.

For ordering codes for the XMC1300 please contact your sales representative or local distributor.

This document describes several derivatives of the XMC1300 series, some descriptions may not apply to a specific product. Please see **Table 1**.

For simplicity the term **XMC1300** is used for all derivatives throughout this document.

1.2 Device Types

These device types are available and can be ordered through Infineon’s direct and/or distribution channels.

Table 1 Synopsis of XMC1300 **Device Types**

Derivative	Package	Flash Kbytes	SRAM Kbytes
XMC1301-T016F0008	PG-TSSOP-16-8	8	16
XMC1301-T016F0016	PG-TSSOP-16-8	16	16
XMC1301-T016X0008	PG-TSSOP-16-8	8	16
XMC1301-T016X0016	PG-TSSOP-16-8	16	16

Table 1 Synopsis of XMC1300 Device Types (cont'd)

Derivative	Package	Flash Kbytes	SRAM Kbytes
XMC1302-T016X0008	PG-TSSOP-16-8	8	16
XMC1302-T016X0016	PG-TSSOP-16-8	16	16
XMC1302-T016X0032	PG-TSSOP-16-8	32	16
XMC1301-T038F0008	PG-TSSOP-38-9	8	16
XMC1301-T038F0016	PG-TSSOP-38-9	16	16
XMC1301-T038F0032	PG-TSSOP-38-9	32	16
XMC1302-T038X0016	PG-TSSOP-38-9	16	16
XMC1302-T038X0032	PG-TSSOP-38-9	32	16
XMC1302-T038X0064	PG-TSSOP-38-9	64	16
XMC1302-T038X0128	PG-TSSOP-38-9	128	16
XMC1302-T038X0200	PG-TSSOP-38-9	200	16
XMC1301-Q024F0008	PG-VQFN-24-19	8	16
XMC1301-Q024F0016	PG-VQFN-24-19	16	16
XMC1302-Q024F0016	PG-VQFN-24-19	16	16
XMC1302-Q024F0032	PG-VQFN-24-19	32	16
XMC1302-Q024F0064	PG-VQFN-24-19	64	16
XMC1302-Q024X0016	PG-VQFN-24-19	16	16
XMC1302-Q024X0032	PG-VQFN-24-19	32	16
XMC1302-Q024X0064	PG-VQFN-24-19	64	16
XMC1301-Q040F0008	PG-VQFN-40-13	8	16
XMC1301-Q040F0016	PG-VQFN-40-13	16	16
XMC1301-Q040F0032	PG-VQFN-40-13	32	16
XMC1302-Q040X0016	PG-VQFN-40-13	16	16
XMC1302-Q040X0032	PG-VQFN-40-13	32	16
XMC1302-Q040X0064	PG-VQFN-40-13	64	16
XMC1302-Q040X0128	PG-VQFN-40-13	128	16

1.3 Device Type Features

The following table lists the available features per device type.

Table 2 Features of XMC1300 Device Types[1)]

Derivative	ADC channel	ACMP	BCCU	MATH
XMC1301-T016	11	2	-	-
XMC1302-T016	11	2	1	1
XMC1301-T038	16	3	-	-
XMC1302-T038	16	3	1	1
XMC1301-Q024	13	3	-	-
XMC1302-Q024	13	3	1	1
XMC1301-Q040	16	3	-	-
XMC1302-Q040	16	3	1	1

1) Features that are not included in this table are available in all the derivatives

Table 3 ADC Channels [1)]

Package	VADC0 G0	VADC0 G1
PG-TSSOP-16	CH0..CH5	CH0..CH4
PG-TSSOP-28	CH0..CH7	CH0 .. CH4, CH7
PG-TSSOP-38	CH0..CH7	CH0..CH7
PG-VQFN-24	CH0..CH7	CH0..CH4
PG-VQFN-40	CH0..CH7	CH1, CH5 .. CH7

1) Some pins in a package may be connected to more than one channel. For the detailed mapping see the Port I/O Function table.

1.4 Chip Identification Number

The Chip Identification Number allows software to identify the marking. It is a 8 words value with the most significant 7 words stored in Flash configuration sector 0 (CS0) at address location : 1000 $0F00_H$ (MSB) - 1000 $0F1B_H$ (LSB). The least significant word and most significant word of the Chip Identification Number are the value of registers DBGROMID and IDCHIP, respectively.

Table 4 XMC1300 Chip Identification Number

Derivative	Value	Marking
XMC1301-T016F0008	00013032 01CF00FF 00001FF7 0000100F 00000B00 00001000 00003000 101ED083$_H$	AA
XMC1301-T016F0016	00013032 01CF00FF 00001FF7 0000100F 00000B00 00001000 00005000 101ED083$_H$	AA
XMC1301-T016X0008	00013033 01CF00FF 00001FF7 0000100F 00000B00 00001000 00003000 101ED083$_H$	AA
XMC1301-T016X0016	00013033 01CF00FF 00001FF7 0000100F 00000B00 00001000 00005000 101ED083$_H$	AA
XMC1302-T016X0008	00013033 01FF00FF 00001FF7 0000900F 00000B00 00001000 00003000 101ED083$_H$	AA
XMC1302-T016X0016	00013033 01FF00FF 00001FF7 0000900F 00000B00 00001000 00005000 101ED083$_H$	AA
XMC1302-T016X0032	00013033 01FF00FF 00001FF7 0000900F 00000B00 00001000 00009000 101ED083$_H$	AA
XMC1301-T038F0008	00013012 01CF00FF 00001FF7 0000100F 00000B00 00001000 00003000 101ED083$_H$	AA
XMC1301-T038F0016	00013012 01CF00FF 00001FF7 0000100F 00000B00 00001000 00005000 101ED083$_H$	AA
XMC1301-T038F0032	00013012 01CF00FF 00001FF7 0000100F 00000B00 00001000 00009000 101ED083$_H$	AA
XMC1302-T038X0016	00013013 01FF00FF 00001FF7 0000900F 00000B00 00001000 00005000 101ED083$_H$	AA
XMC1302-T038X0032	00013013 01FF00FF 00001FF7 0000900F 00000B00 00001000 00009000 101ED083$_H$	AA
XMC1302-T038X0064	00013013 01FF00FF 00001FF7 0000900F 00000B00 00001000 00011000 101ED083$_H$	AA
XMC1302-T038X0128	00013013 01FF00FF 00001FF7 0000900F 00000B00 00001000 00021000 101ED083$_H$	AA
XMC1302-T038X0200	00013013 01FF00FF 00001FF7 0000900F 00000B00 00001000 00033000 101ED083$_H$	AA
XMC1301-Q024F0008	00013062 01CF00FF 00001FF7 0000100F 00000B00 00001000 00003000 101ED083$_H$	AA
XMC1301-Q024F0016	00013062 01CF00FF 00001FF7 0000100F 00000B00 00001000 00005000 101ED083$_H$	AA

Table 4 XMC1300 Chip Identification Number (cont'd)

Derivative	Value	Marking
XMC1302-Q024F0016	00013062 01FF00FF 00001FF7 0000900F 00000B00 00001000 00005000 101ED083$_H$	AA
XMC1302-Q024F0032	00013062 01FF00FF 00001FF7 0000900F 00000B00 00001000 00009000 101ED083$_H$	AA
XMC1302-Q024F0064	00013062 01FF00FF 00001FF7 0000900F 00000B00 00001000 00011000 101ED083$_H$	AA
XMC1302-Q024X0016	00013063 01FF00FF 00001FF7 0000900F 00000B00 00001000 00005000 101ED083$_H$	AA
XMC1302-Q024X0032	00013063 01FF00FF 00001FF7 0000900F 00000B00 00001000 00009000 101ED083$_H$	AA
XMC1302-Q024X0064	00013063 01FF00FF 00001FF7 0000900F 00000B00 00001000 00011000 101ED083$_H$	AA
XMC1301-Q040F0008	00013042 01CF00FF 00001FF7 0000100F 00000B00 00001000 00003000 101ED083$_H$	AA
XMC1301-Q040F0016	00013042 01CF00FF 00001FF7 0000100F 00000B00 00001000 00005000 101ED083$_H$	AA
XMC1301-Q040F0032	00013042 01CF00FF 00001FF7 0000100F 00000B00 00001000 00009000 101ED083$_H$	AA
XMC1302-Q040X0016	00013043 01FF00FF 00001FF7 0000900F 00000B00 00001000 00005000 101ED083$_H$	AA
XMC1302-Q040X0032	00013043 01FF00FF 00001FF7 0000900F 00000B00 00001000 00009000 101ED083$_H$	AA
XMC1302-Q040X0064	00013043 01FF00FF 00001FF7 0000900F 00000B00 00001000 00011000 101ED083$_H$	AA
XMC1302-Q040X0128	00013043 01FF00FF 00001FF7 0000900F 00000B00 00001000 00021000 101ED083$_H$	AA

2 General Device Information

This section summarizes the logic symbols and package pin configurations with a detailed list of the functional I/O mapping.

2.1 Logic Symbols

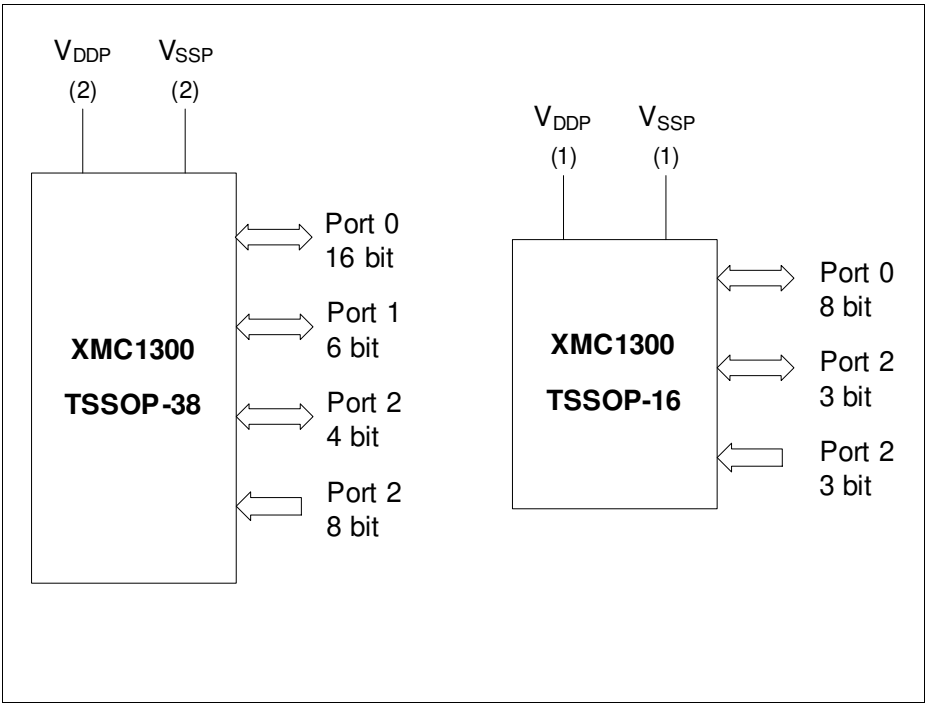

Figure 2 XMC1300 Logic Symbol for TSSOP-38 and TSSOP-16

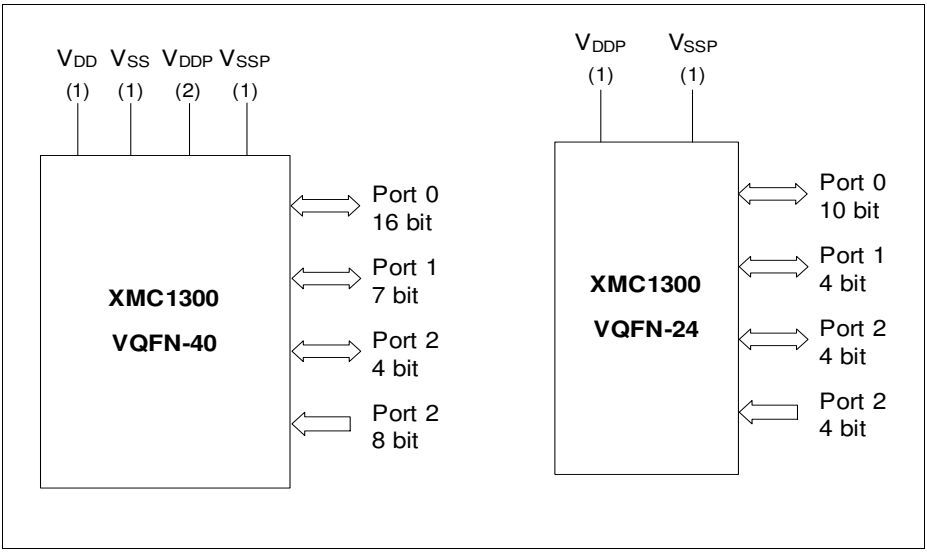

Figure 3 XMC1300 Logic Symbol for VQFN-24 and VQFN-40

2.2 Pin Configuration and Definition

The following figures summarize all pins, showing their locations on the different packages.

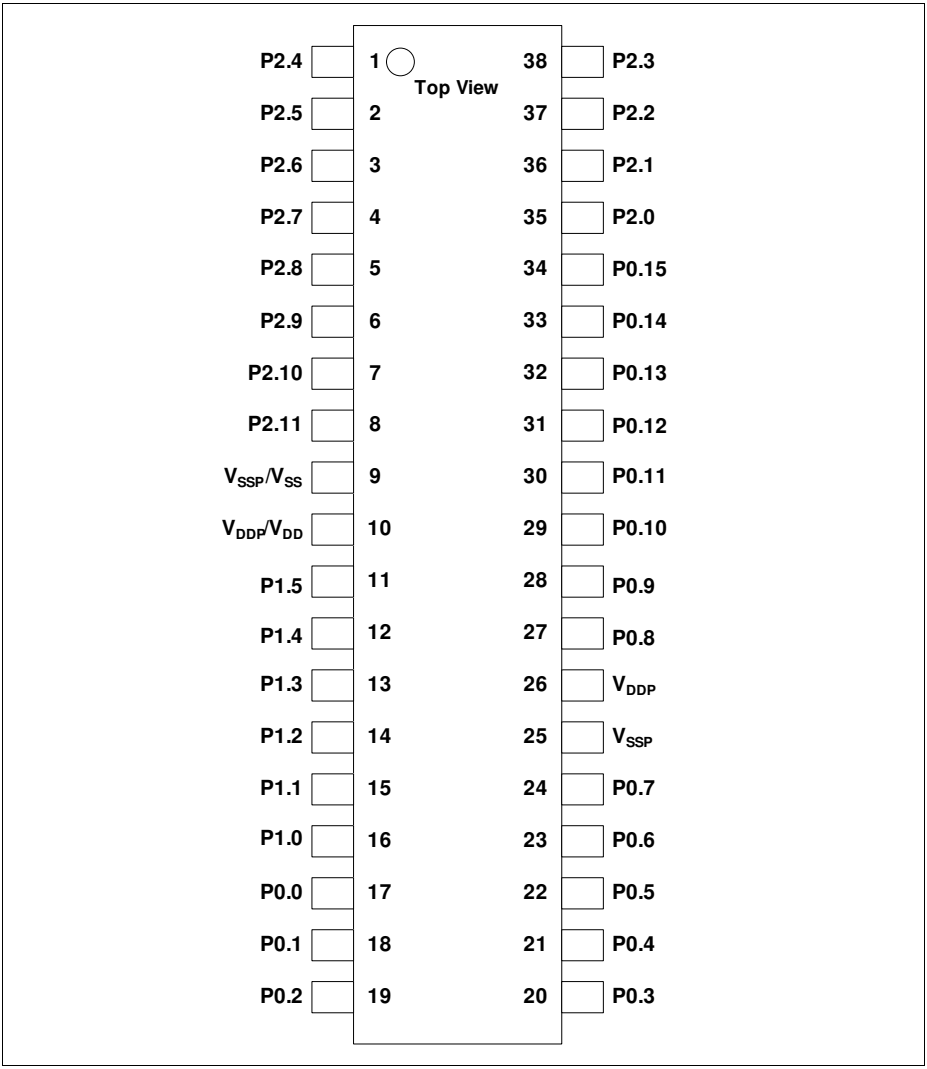

Figure 4 XMC1300 PG-TSSOP-38 Pin Configuration (top view)

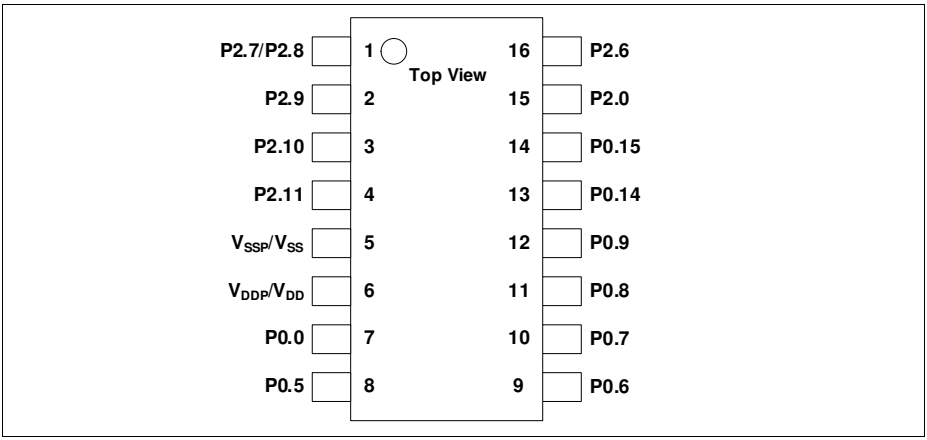

Figure 5 XMC1300 PG-TSSOP-16 Pin Configuration (top view)

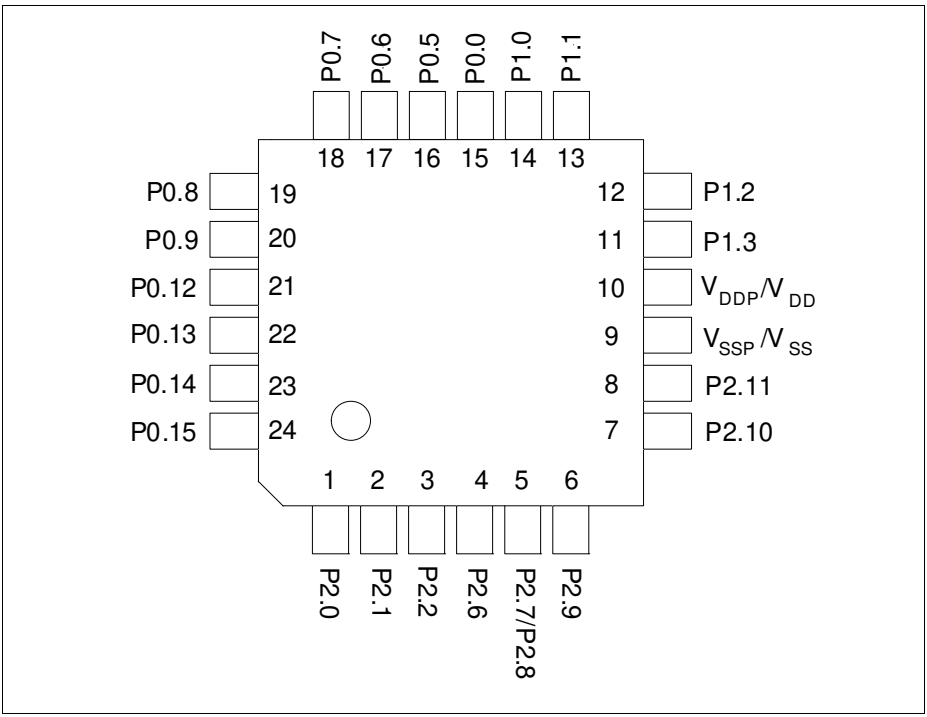

Figure 6 XMC1300 PG-VQFN-24 Pin Configuration (top view)

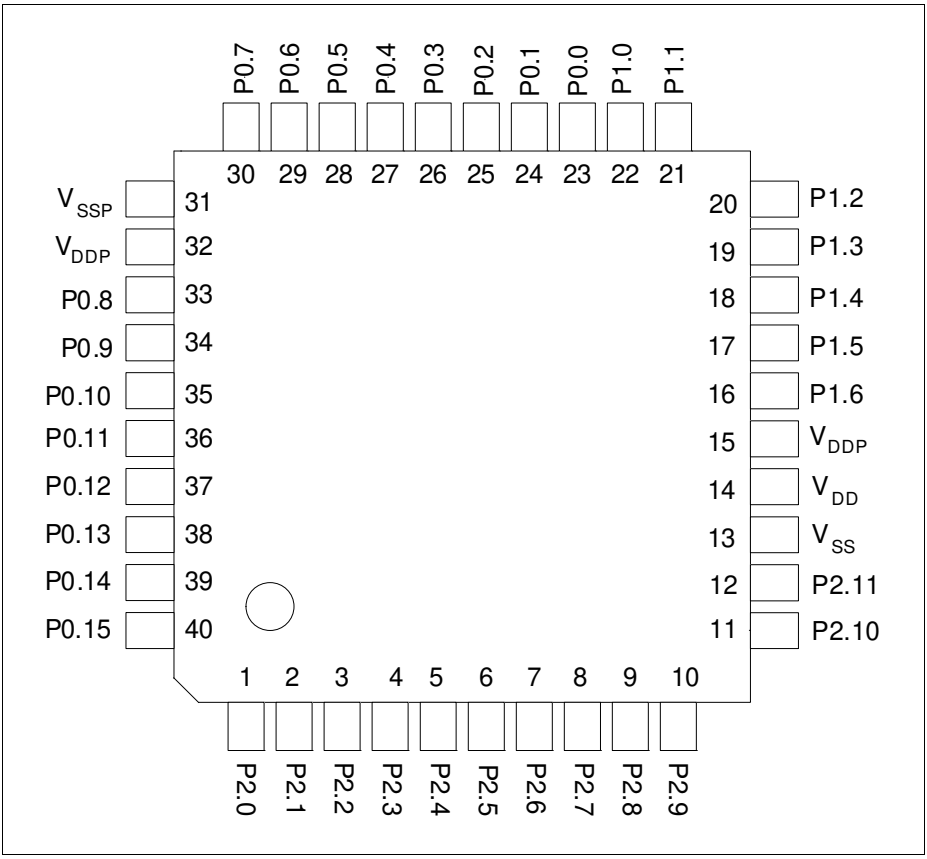

Figure 7 XMC1300 PG-VQFN-40 Pin Configuration (top view)

2.2.1 Package Pin Summary

The following general building block is used to describe each pin:

Table 5 Package Pin Mapping Description

Function	Package A	Package B	...	Pad Type
Px.y	N	N		Pad Class

The table is sorted by the “Function” column, starting with the regular Port pins (Px.y), followed by the supply pins.

The following columns, titled with the supported package variants, lists the package pin number to which the respective function is mapped in that package.

The “Pad Type” indicates the employed pad type:

- STD_INOUT(standard bi-directional pads)
- STD_INOUT/AN (standard bi-directional pads with analog input)
- High Current (high current bi-directional pads)
- STD_IN/AN (standard input pads with analog input)
- Power (power supply)

Details about the pad properties are defined in the Electrical Parameters.

Table 6 Package Pin Mapping

Function	VQFN 40	TSSOP 38	VQFN 24	TSSOP 16	Pad Type	Notes
P0.0	23	17	15	7	STD_INOUT	
P0.1	24	18	-	-	STD_INOUT	
P0.2	25	19	-	-	STD_INOUT	
P0.3	26	20	-	-	STD_INOUT	
P0.4	27	21	-	-	STD_INOUT	
P0.5	28	22	16	8	STD_INOUT	
P0.6	29	23	17	9	STD_INOUT	
P0.7	30	24	18	10	STD_INOUT	
P0.8	33	27	19	11	STD_INOUT	
P0.9	34	28	20	12	STD_INOUT	
P0.10	35	29	-	-	STD_INOUT	
P0.11	36	30	-	-	STD_INOUT	
P0.12	37	31	21	-	STD_INOUT	

Table 6 Package Pin Mapping

Function	VQFN 40	TSSOP 38	VQFN 24	TSSOP 16	Pad Type	Notes
P0.13	38	32	22	-	STD_INOUT	
P0.14	39	33	23	13	STD_INOUT	
P0.15	40	34	24	14	STD_INOUT	
P1.0	22	16	14	-	High Current	
P1.1	21	15	13	-	High Current	
P1.2	20	14	12	-	High Current	
P1.3	19	13	11	-	High Current	
P1.4	18	12	-	-	High Current	
P1.5	17	11	-	-	High Current	
P1.6	16	-	-	-	STD_INOUT	
P2.0	1	35	1	15	STD_INOUT/AN	
P2.1	2	36	2	-	STD_INOUT/AN	
P2.2	3	37	3	-	STD_IN/AN	
P2.3	4	38	-	-	STD_IN/AN	
P2.4	5	1	-	-	STD_IN/AN	
P2.5	6	2	-	-	STD_IN/AN	
P2.6	7	3	4	16	STD_IN/AN	
P2.7	8	4	5	1	STD_IN/AN	
P2.8	9	5	5	1	STD_IN/AN	
P2.9	10	6	6	2	STD_IN/AN	
P2.10	11	7	7	3	STD_INOUT/AN	
P2.11	12	8	8	4	STD_INOUT/AN	
VSS	13	9	9	5	Power	Supply GND, ADC reference GND
VDD	14	10	10	6	Power	Supply VDD, ADC reference voltage/ ORC reference voltage. VDD has to be supplied with the same voltage as VDDP

Table 6 Package Pin Mapping

Function	VQFN 40	TSSOP 38	VQFN 24	TSSOP 16	Pad Type	Notes
VDDP	15	10	10	6	Power	I/O port supply
VSSP	31	25	-	-	Power	I/O port ground
VDDP	32	26	-	-	Power	I/O port supply
VSSP	Exp. Pad	-	Exp. Pad	-	Power	**Exposed Die Pad** The exposed die pad is connected internally to VSSP. For proper operation, it is mandatory to connect the exposed pad to the board ground. For thermal aspects, please refer to the Package and Reliability chapter.

2.2.2 Port I/O Functions

The following general building block is used to describe each PORT pin:

Table 7 Port I/O Function Description

Function	Outputs			Inputs		
	ALT1	ALTn	HWO0	HWI0	Input	Input
P0.0		MODA.OUT	MODB.OUT	MODB.INA	MODC.INA	
Pn.y	MODA.OUT				MODA.INA	MODC.INB

Pn.y is the port pin name, defining the control and data bits/registers associated with it. As GPIO, the port is under software control. Its input value is read via Pn_IN.y, Pn_OUT defines the output value.

Up to seven alternate output functions (ALT1/2/3/4/5/6/7) can be mapped to a single port pin, selected by Pn_IOCR.PC. The output value is directly driven by the respective module, with the pin characteristics controlled by the port registers (within the limits of the connected pad).

The port pin input can be connected to multiple peripherals. Most peripherals have an input multiplexer to select between different possible input sources.

The input path is also active while the pin is configured as output. This allows to feedback an output to on-chip resources without wasting an additional external pin.

By Pn_HWSEL, it is possible to select between different hardware “masters” (HWO0/HWI0, HWO1/HWI1). The selected peripheral can take control of the pin(s). Hardware control overrules settings in the respective port pin registers.

Table 8 Port I/O Functions

Function	Outputs									Inputs											
	ALT1	ALT2	ALT3	ALT4	ALT5	ALT6	ALT7	HWO0	HWO1	HWI0	HWI1	Input	Input	Input	Input	Input	Input	Input	Input	Input	Input
P0.0	ERU0.PDOUT0		ERU0.GOUT0	CCU40.OUT0	CCU80.OUT00	USIC0_CH0.SELO0	USIC0_CH1.SELO0					BCCU0.TRAPINB	CCU40.IN0C			USIC0_CH0.DX2A	USIC0_CH1.DX2A				
P0.1	ERU0.PDOUT1		ERU0.GOUT1	CCU40.OUT1	CCU80.OUT01	BCCU0.OUT8	SCU.VDROP						CCU40.IN1C								
P0.2	ERU0.PDOUT2		ERU0.GOUT2	CCU40.OUT2	CCU80.OUT02	VADC0.EMUX02	CCU80.OUT10						CCU40.IN2C								
P0.3	ERU0.PDOUT3		ERU0.GOUT3	CCU40.OUT3	CCU80.OUT03	VADC0.EMUX01	CCU80.OUT11						CCU40.IN3C								
P0.4	BCCU0.OUT0			CCU40.OUT1	CCU80.OUT13	VADC0.EMUX00	WWDT.SERVICE_OUT						CCU80.IN0B								
P0.5	BCCU0.OUT1			CCU40.OUT0	CCU80.OUT12	ACMP2.OUT	CCU80.OUT01						CCU80.IN1B								
P0.6	BCCU0.OUT2			CCU40.OUT0	CCU80.OUT11	USIC0_CH1.MCLKOUT	USIC0_CH1.DOUT0						CCU40.IN0B			USIC0_CH1.DX0C					
P0.7	BCCU0.OUT3			CCU40.OUT1	CCU80.OUT10	USIC0_CH0.SCLKOUT	USIC0_CH1.DOUT0						CCU40.IN1B			USIC0_CH0.DX1C	USIC0_CH1.DX0D	USIC0_CH1.DX1C			
P0.8	BCCU0.OUT4			CCU40.OUT2	CCU80.OUT20	USIC0_CH0.SCLKOUT	USIC0_CH1.SCLKOUT						CCU40.IN2B			USIC0_CH0.DX1B	USIC0_CH1.DX1B				
P0.9	BCCU0.OUT5			CCU40.OUT3	CCU80.OUT21	USIC0_CH0.SELO0	USIC0_CH1.SELO0						CCU40.IN3B			USIC0_CH0.DX2B	USIC0_CH1.DX2B				
P0.10	BCCU0.OUT6			ACMP0.OUT	CCU80.OUT22	USIC0_CH0.SELO1	USIC0_CH1.SELO1						CCU80.IN2B			USIC0_CH0.DX2C	USIC0_CH1.DX2C				
P0.11	BCCU0.OUT7			USIC0_CH0.MCLKOUT	CCU80.OUT23	USIC0_CH0.SELO2	USIC0_CH1.SELO2									USIC0_CH0.DX2D	USIC0_CH1.DX2D				
P0.12	BCCU0.OUT6				CCU80.OUT33	USIC0_CH0.SELO3	CCU80.OUT20					BCCU0.TRAPINA	CCU40.IN0A	CCU40.IN1A	CCU40.IN2A	CCU40.IN3A	CCU80.IN0A	CCU80.IN1A	CCU80.IN2A	CCU80.IN3A	USIC0_CH0.DX2E
P0.13	WWDT.SERVICE_OUT				CCU80.OUT32	USIC0_CH0.SELO4	CCU80.OUT21						CCU80.IN3B	POSIF0.IN0B		USIC0_CH0.DX2F					
P0.14	BCCU0.OUT7				CCU80.OUT31	USIC0_CH0.DOUT0	USIC0_CH0.SCLKOUT							POSIF0.IN1B		USIC0_CH0.DX0A	USIC0_CH0.DX1A				
P0.15	BCCU0.OUT8				CCU80.OUT30	USIC0_CH0.DOUT0	USIC0_CH1.MCLKOUT							POSIF0.IN2B		USIC0_CH0.DX0B					
P1.0	BCCU0.OUT0	CCU40.OUT0			CCU80.OUT00	ACMP1.OUT	USIC0_CH0.DOUT0		USIC0_CH0.DOUT0		USIC0_CH0.HWIN0			POSIF0.IN2A		USIC0_CH0.DX0C					
P1.1	VADC0.EMUX00	CCU40.OUT1			CCU80.OUT01	USIC0_CH0.DOUT0	USIC0_CH1.SELO0		USIC0_CH0.DOUT1		USIC0_CH0.HWIN1			POSIF0.IN1A		USIC0_CH0.DX0D	USIC0_CH0.DX1D	USIC0_CH1.DX2E			
P1.2	VADC0.EMUX01	CCU40.OUT2			CCU80.OUT10	ACMP2.OUT	USIC0_CH1.DOUT0		USIC0_CH0.DOUT2		USIC0_CH0.HWIN2			POSIF0.IN0A		USIC0_CH1.DX0B					
P1.3	VADC0.EMUX02	CCU40.OUT3			CCU80.OUT11	USIC0_CH1.SCLKOUT	USIC0_CH1.DOUT0		USIC0_CH0.DOUT3		USIC0_CH0.HWIN3					USIC0_CH1.DX0A	USIC0_CH1.DX1A				
P1.4	VADC0.EMUX10	USIC0_CH1.SCLKOUT			CCU80.OUT20	USIC0_CH0.SELO0	USIC0_CH1.SELO1									USIC0_CH0.DX5E	USIC0_CH1.DX5E				
P1.5	VADC0.EMUX11	USIC0_CH0.DOUT0		BCCU0.OUT1	CCU80.OUT21	USIC0_CH0.SELO1	USIC0_CH1.SELO2									USIC0_CH1.DX5F					

Table 8 Port I/O Functions (cont'd)

Function	Outputs									Inputs											
	ALT1	ALT2	ALT3	ALT4	ALT5	ALT6	ALT7	HWO0	HWO1	HWI0	HWI1	Input	Input	Input	Input	Input	Input	Input	Input	Input	Input
P1.6	VADC0.EMUX12	USIC0_CH1.DOUT0		USIC0_CH0.SCLKOUT	BCCU0.OUT2	USIC0_CH0.SELO2	USIC0_CH1.SELO3							USIC0_CH0.DX5F							
P2.0	ERU0.PDOUT3	CCU40.OUT0	ERU0.GOUT3		CCU80.OUT20	USIC0_CH0.DOUT0	USIC0_CH0.SCLKOUT						VADC0.G0CH5		ERU0.0B0	USIC0_CH0.DX0E	USIC0_CH0.DX1E	USIC0_CH1.DX2F			
P2.1	ERU0.PDOUT2	CCU40.OUT1	ERU0.GOUT2		CCU80.OUT21	USIC0_CH0.DOUT0	USIC0_CH1.SCLKOUT					ACMP2.INP	VADC0.G0CH6		ERU0.1B0	USIC0_CH0.DX0F	USIC0_CH1.DX3A	USIC0_CH1.DX4A			
P2.2												ACMP2.INN	VADC0.G0CH7		ERU0.0B1	USIC0_CH0.DX3A	USIC0_CH0.DX4A	USIC0_CH1.DX5A	ORC0.AIN		
P2.3													VADC0.G1CH5		ERU0.1B1	USIC0_CH0.DX5B	USIC0_CH1.DX3C	USIC0_CH1.DX4C	ORC1.AIN		
P2.4													VADC0.G1CH6		ERU0.0A1	USIC0_CH0.DX3B	USIC0_CH0.DX4B	USIC0_CH1.DX5B	ORC2.AIN		
P2.5													VADC0.G1CH7		ERU0.1A1	USIC0_CH0.DX5D	USIC0_CH1.DX3E	USIC0_CH1.DX4E	ORC3.AIN		
P2.6												ACMP1.INN	VADC0.G0CH0		ERU0.2A1	USIC0_CH0.DX3E	USIC0_CH0.DX4E	USIC0_CH1.DX5D	ORC4.AIN		
P2.7												ACMP1.INP	VADC0.G1CH1		ERU0.3A1	USIC0_CH0.DX5C	USIC0_CH1.DX3D	USIC0_CH1.DX4D	ORC5.AIN		
P2.8												ACMP0.INN	VADC0.G0CH1	VADC0.G1CH0	ERU0.3B1	USIC0_CH0.DX3D	USIC0_CH0.DX4D	USIC0_CH1.DX5C	ORC6.AIN		
P2.9												ACMP0.INP	VADC0.G0CH2	VADC0.G1CH4	ERU0.3B0	USIC0_CH0.DX5A	USIC0_CH1.DX3B	USIC0_CH1.DX4B	ORC7.AIN		
P2.10	ERU0.PDOUT1	CCU40.OUT2	ERU0.GOUT1		CCU80.OUT30	ACMP0.OUT	USIC0_CH1.DOUT0						VADC0.G0CH3	VADC0.G1CH2	ERU0.2B0	USIC0_CH0.DX3C	USIC0_CH0.DX4C	USIC0_CH1.DX0F			
P2.11	ERU0.PDOUT0	CCU40.OUT3	ERU0.GOUT0		CCU80.OUT31	USIC0_CH1.SCLKOUT	USIC0_CH1.DOUT0					ACMP.REF	VADC0.G0CH4	VADC0.G1CH3	ERU0.2B1	USIC0_CH1.DX0E	USIC0_CH1.DX1E				